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(12)

United States Design Patent

Mao et al.

(10)

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(45)

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(54) **CIRCUIT BOARD**

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(73) Assignee: **Canaan Creative Co., LTD.**, Beijing (CN)

(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (15) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/182**

(58) **Field of Classification Search**
USPC D13/182; 361/748, 752, 760, 761, 807, 361/808, 736, 719, 720; 174/250, 253, 174/255, 68.1; 363/144, 147
CPC H05K 3/30; H05K 3/301; H05K 3/284; H05K 3/303; H05K 1/18; H05K 1/181; H05K 1/182; H05K 1/183; H05K 1/185; H05K 1/00; H05K 7/1417; H05K 7/02; H05K 7/12; H05K 7/06; H01L 2924/14
See application file for complete search history.

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Primary Examiner — Elizabeth J Oswecki

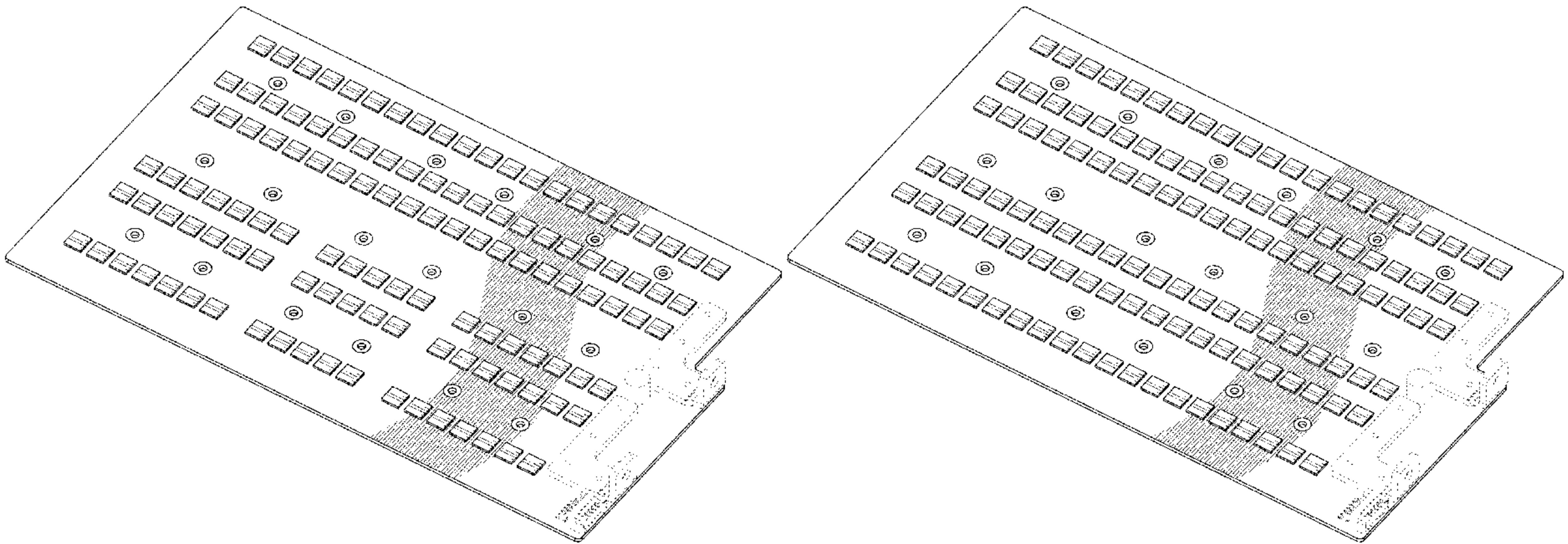
(57) **CLAIM**

The ornamental design for a circuit board, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a first embodiment of a circuit board, showing our new design;
FIG. 2 is a front view thereof;
FIG. 3 is a rear view thereof;
FIG. 4 is a left side view thereof;
FIG. 5 is a right side view thereof;
FIG. 6 is a top view thereof;
FIG. 7 is a bottom view thereof;
FIG. 8 is a perspective view of a second embodiment of a circuit board, showing our new design;
FIG. 9 is a front view thereof;
FIG. 10 is a rear view thereof;
FIG. 11 is a left side view thereof;
FIG. 12 is a right side view thereof;
FIG. 13 is a top view thereof; and,
FIG. 14 is a bottom view thereof.
The broken lines represent an unclaimed boundary of the design or other features that are environmental only, which form no part of the claimed design.

1 Claim, 10 Drawing Sheets



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						361/679.33

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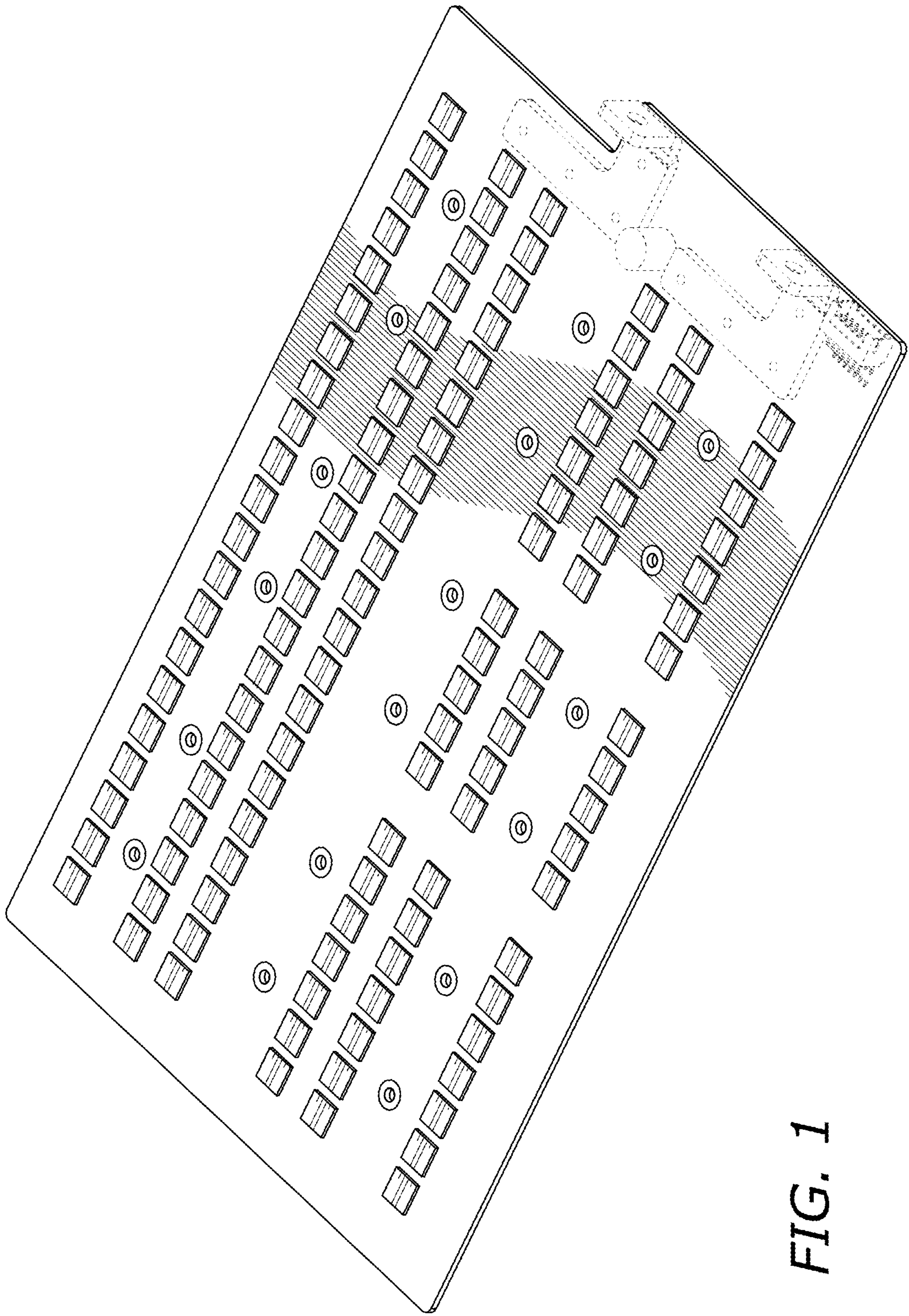


FIG. 1

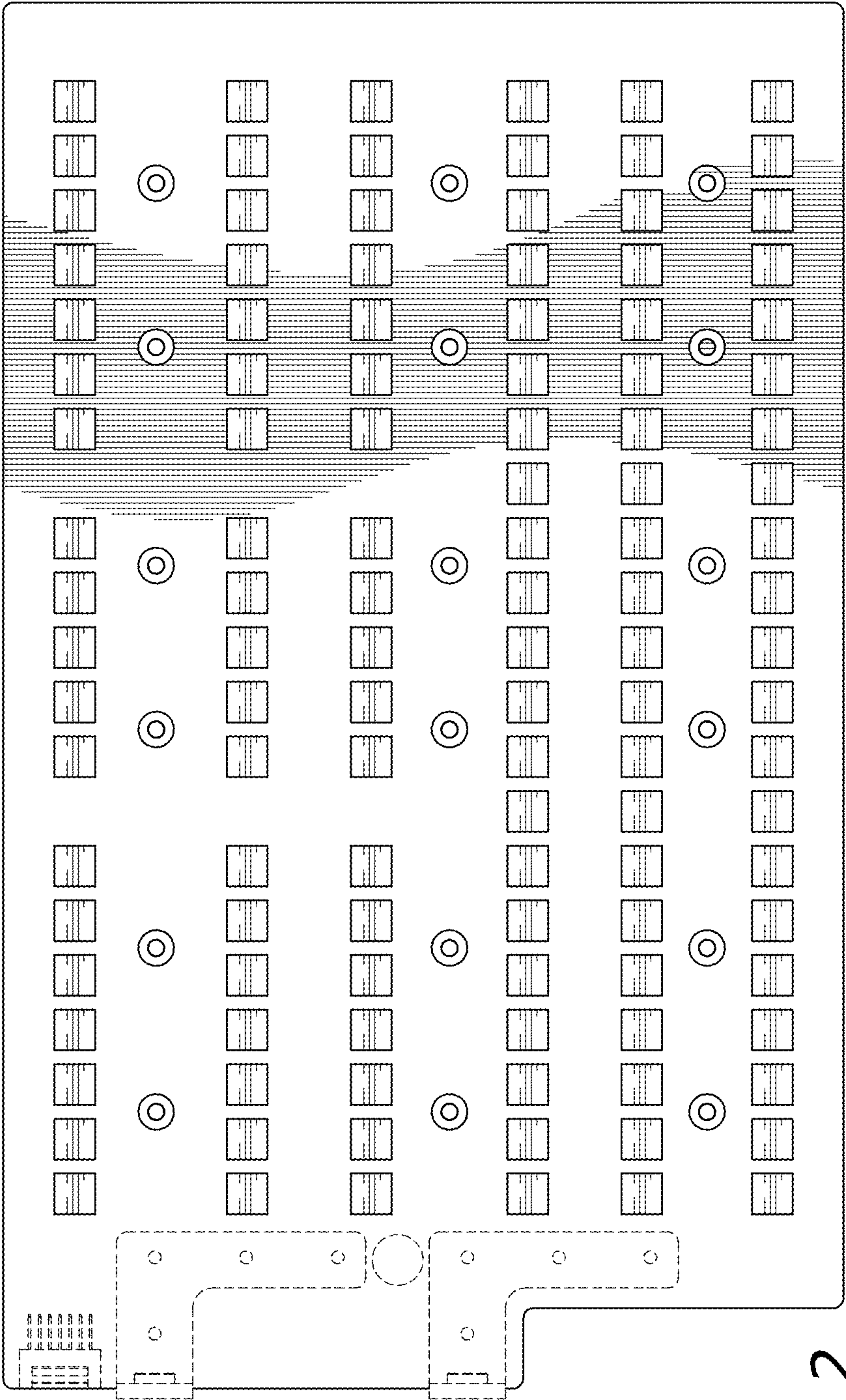


FIG. 2

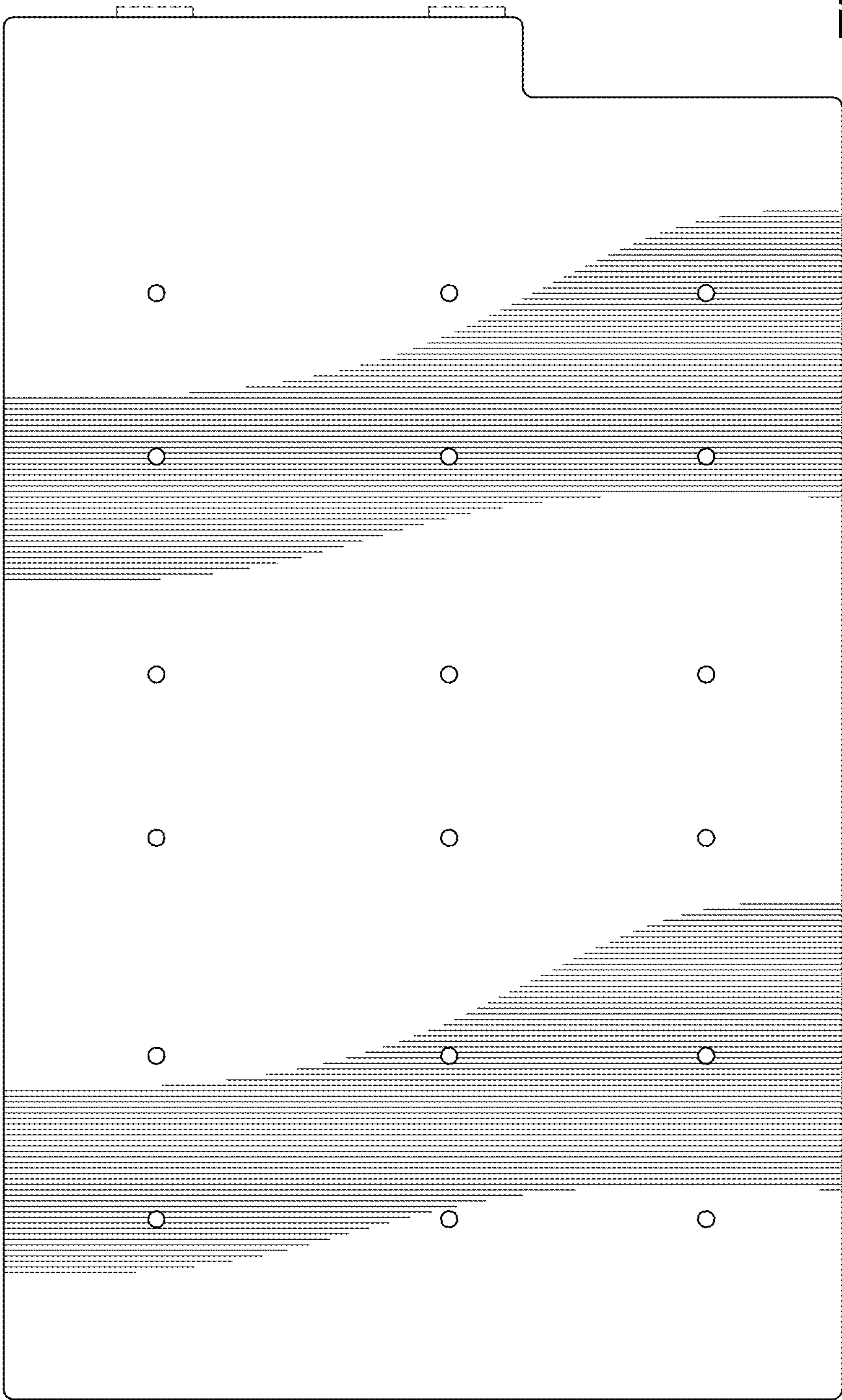


FIG. 3

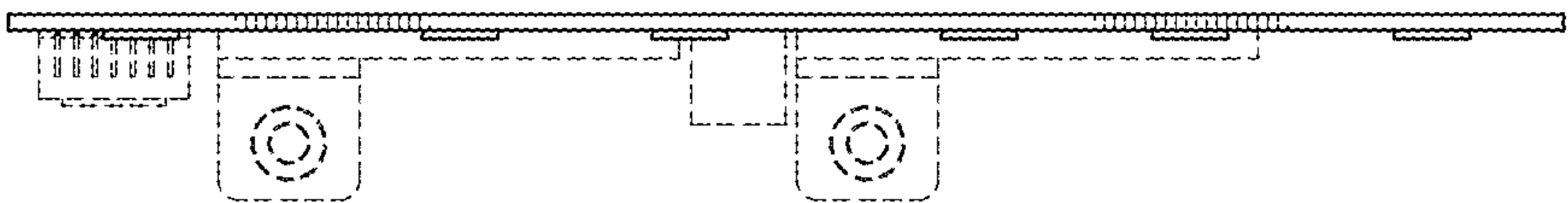


FIG. 5

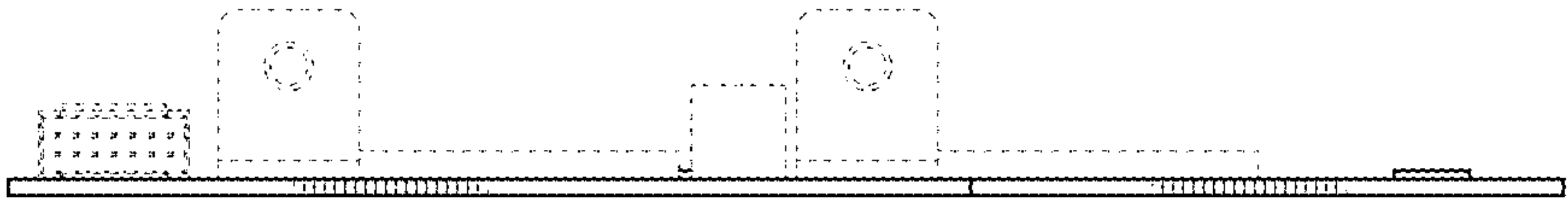


FIG. 4

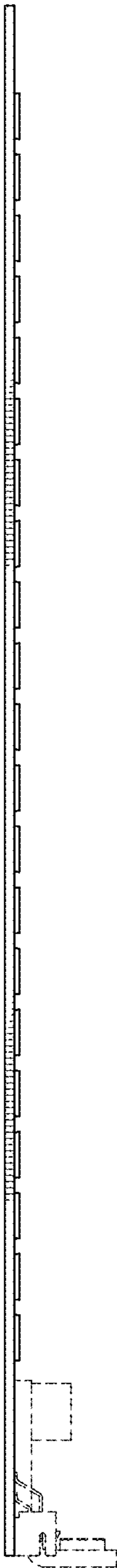


FIG. 6

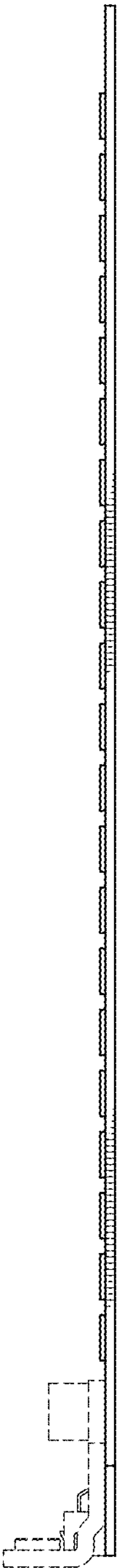
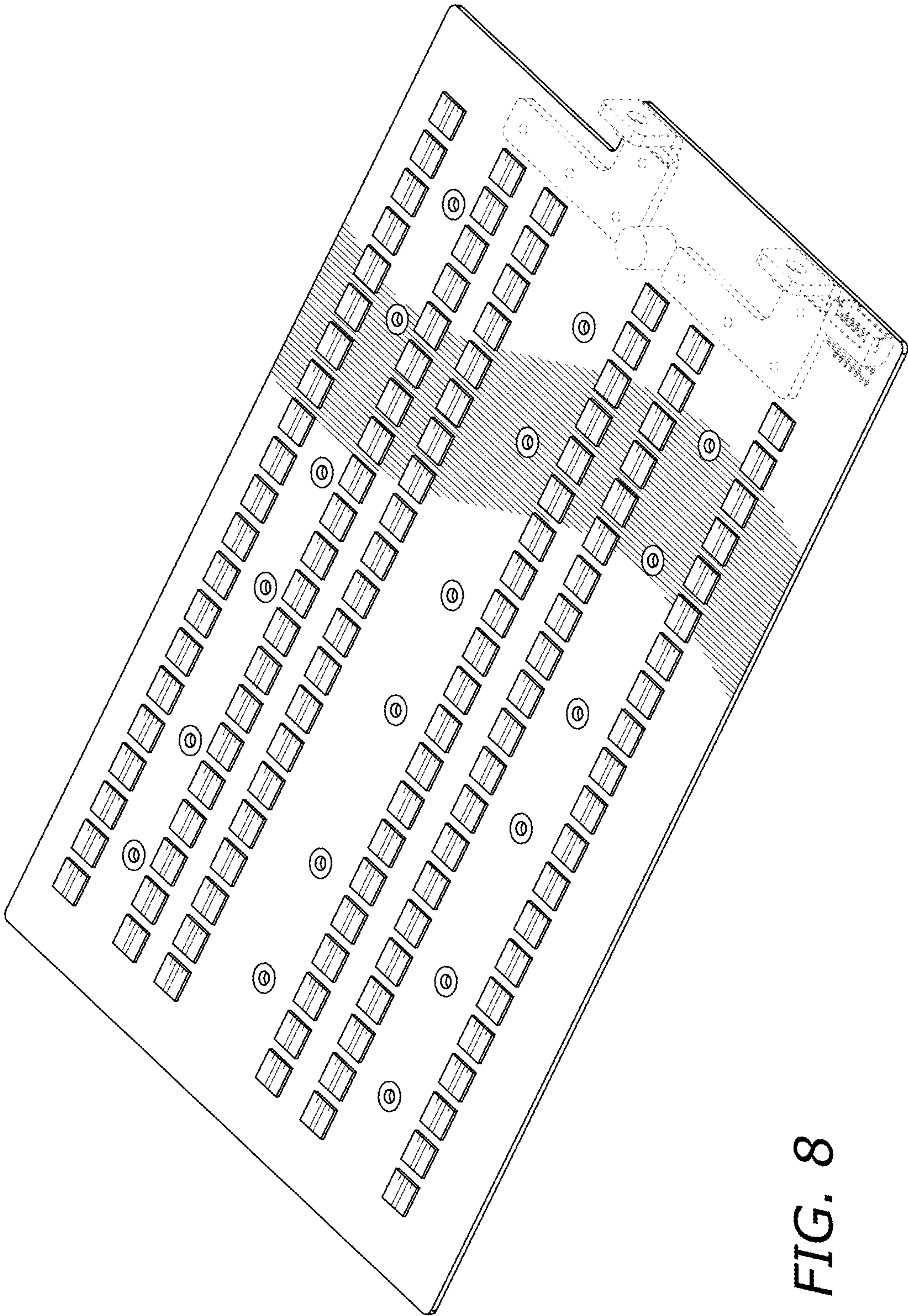


FIG. 7



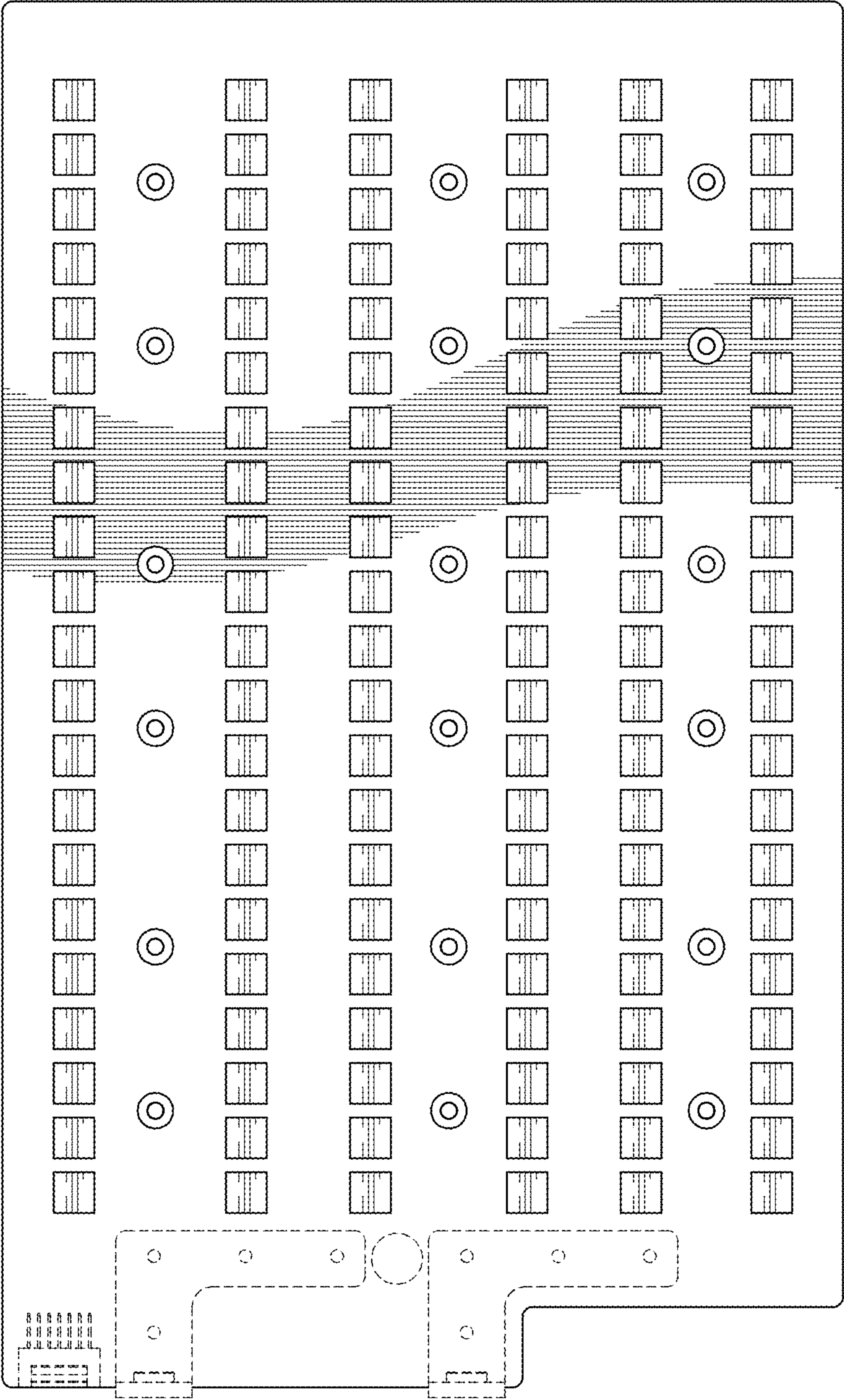


FIG. 9

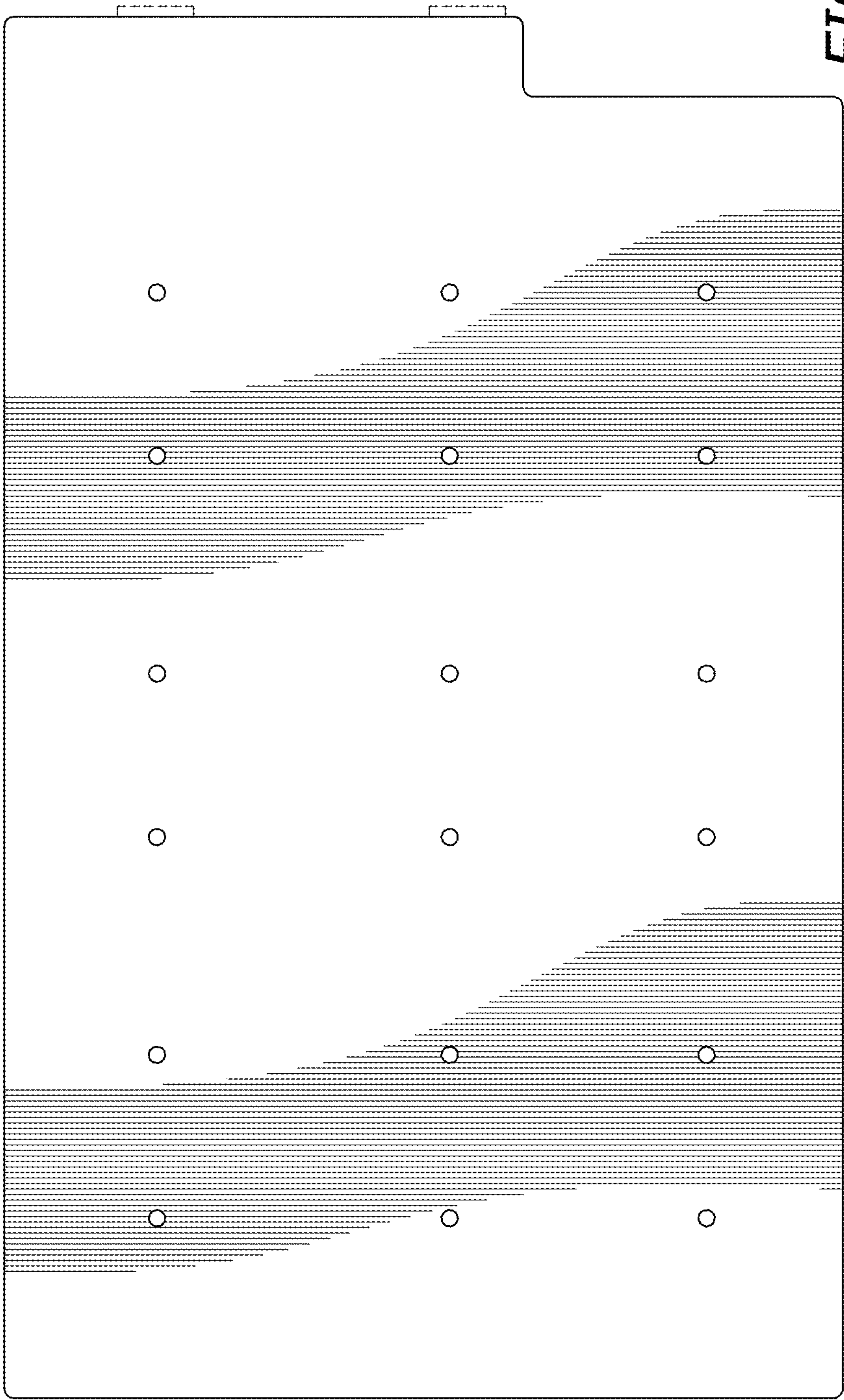


FIG. 10

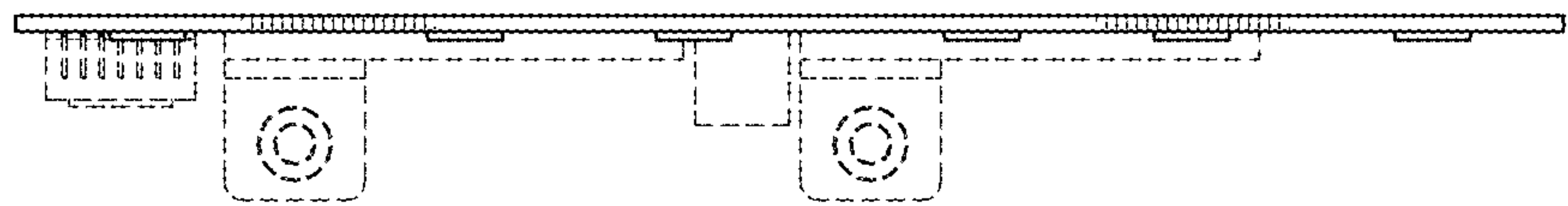


FIG. 11

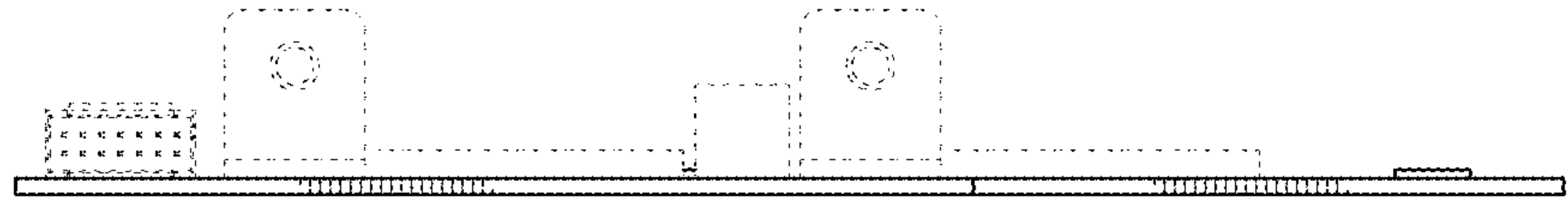


FIG. 12

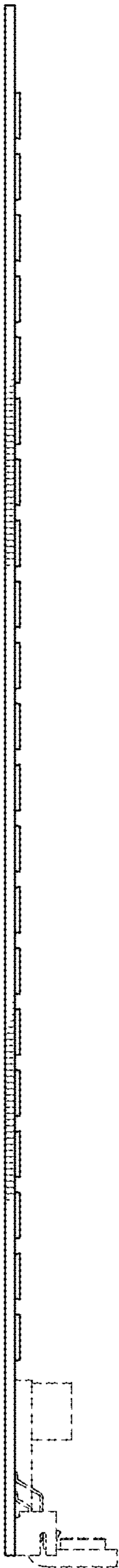


FIG. 13

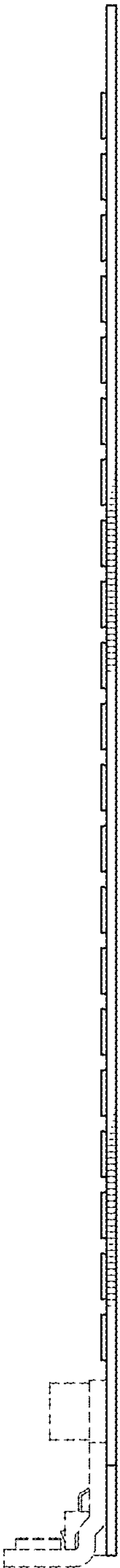


FIG. 14